

# N-Channel SuperFET<sup>®</sup> II MOSFET

### 800 V, 17 A, 0.29 $\Omega$

#### Features

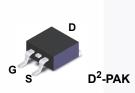
- R<sub>DS(on)</sub> = 0.259 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 58 nC)
- Low E<sub>oss</sub> (Typ. 5.4 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 240 pF)
- 100% Avalanche Tested
- RoHS Compliant

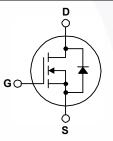
### Applications

- AC DC Power Supply
- LED Lighting

# Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		FCB290N80	Unit				
V <sub>DSS</sub>	Drain to Source Voltage	800	V				
V <sub>GSS</sub>		- DC	- DC		V		
	Gate to Source Voltage	- AC	±30	v			
	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	17				
I <sub>D</sub>	Drain Current	- Continuous ( $T_c = 100^{\circ}C$ )		10.8	A		
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	42	А		
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			882	mJ		
I <sub>AR</sub>	Avalanche Current (Note 1)			3.4	Α		
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)			2.12	mJ		
dv/dt	MOSFET dv/dt	100	V/ns				
	Peak Diode Recovery dv/dt (Note 3)				20		
P <sub>D</sub>	Devues Dissinction	(T <sub>C</sub> = 25 <sup>o</sup> C)		212	W		
	Power Dissipation	- Derate Above 25°C		1.7	W/ºC		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C		
T <sub>I</sub>	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C		

## Thermal Characteristics

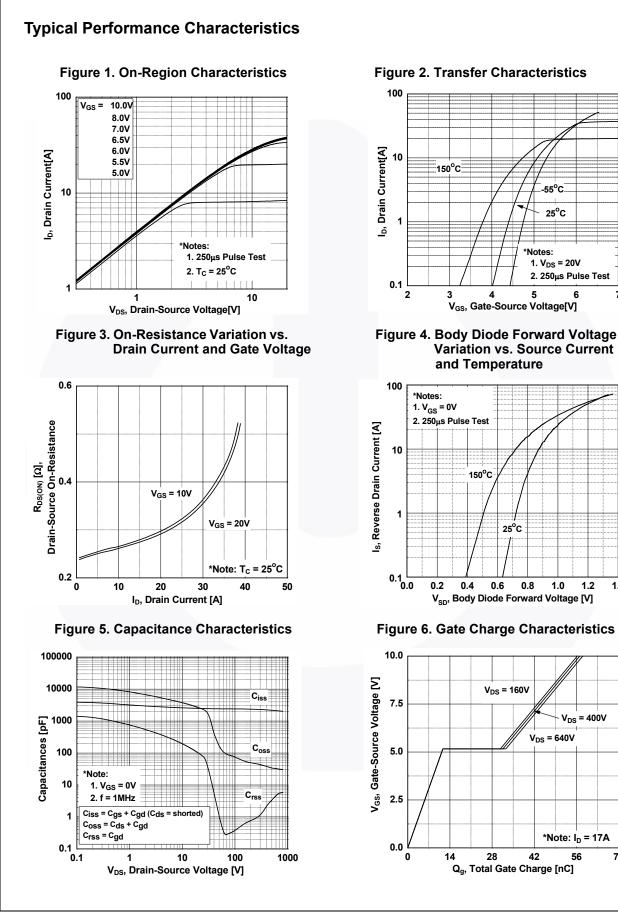
Symbol	Parameter	FCB290N80	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.59	
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (1 in <sup>2</sup> Pad of 2-oz Copper), Max.	40	

FCB290N80 -
- N-Channel
nel SuperFET <sup>®</sup>
<b>II MOSFET</b>

Part Number FCB290N80		r Top Mark Pac		Packing Method	Reel S	ize	Tape Wid	lth Q	Quantity 800 units	
		FCB290N80	D <sup>2</sup> -PAK	<sup>2</sup> -PAK Tape and Reel 330 n		ım	24 mm	8		
Electrica	l Chara	acteristics T <sub>C</sub> = 25%	C unless oth	erwise noted.						
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit	
Off Charac	teristics	3								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage			V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C			-	-	V	
ΔBV <sub>DSS</sub>	Breakdown Voltage Temperature Coefficient			$I_D = 1$ mA, Referenced to 25°C						
$/\Delta T_J$			5				0.85	-	V/ºC	
I <sub>DSS</sub>	Zero Ga	te Voltage Drain Current		800 V, V <sub>GS</sub> = 0 V	-	-	-	25	иА	
.033		•	-	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$			-	250	50 .	
I <sub>GSS</sub>	Gate to I	Body Leakage Current	V <sub>GS</sub> =	$\pm 20 \text{ V}, \text{ V}_{\text{DS}} = 0 \text{ V}$		-	-	±10	μA	
On Charac	teristics	5								
V <sub>GS(th)</sub>	Gate Threshold Voltage		V <sub>GS</sub> =	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 1.7 mA			-	4.5	V	
R <sub>DS(on)</sub>		atic Drain to Source On Resistance		$V_{GS} = 10 \text{ V}, I_D = 8.5 \text{ A}$			0.259	0.290	Ω	
9FS	Forward	Transconductance		$V_{DS} = 20 \text{ V}, I_D = 8.5 \text{ A}$			20	-	S	
	borooto	riation					-		ų.	
Dynamic C							0.110	0005	-	
C <sub>iss</sub>	-	pacitance	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V,		-	2410	3205	pF		
C <sub>oss</sub>		apacitance		_f = 1 MHz		-	75	100	pF	
C <sub>rss</sub>		Reverse Transfer Capacitance   Output Capacitance   Effective Output Capacitance   Total Gate Charge at 10V		V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, f = 1 MHz V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V			0.36	-	pF	
C <sub>oss</sub>							240	-	pF pF	
C <sub>oss(eff.)</sub>						-	58	- 75	nC	
Q <sub>g(tot)</sub>		Source Gate Charge	V <sub>DS</sub> = V <sub>GS</sub> =	= 640 V, I <sub>D</sub> = 17 A, = 10 V	-		11	-	nC	
Q <sub>gs</sub> Q <sub>gd</sub>		Drain "Miller" Charge	VGS −	10 0	(Note 4)	-	22	-	nC	
esr		nt Series Resistance	f = 1 N	MHz	, ,	-	0.75	-	Ω	
							0.1.0			
Switching	Charact	eristics					-1	1	1	
t <sub>d(on)</sub>		Delay Time			-	-	22	54	ns	
t <sub>r</sub>		Rise Time		V <sub>DD</sub> = 400 V, I <sub>D</sub> = 17 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω		-	14	38	ns	
t <sub>d(off)</sub>		Delay Time	v <sub>GS</sub> –	$10 \text{ v}, \text{R}_{\text{g}} = 4.7 \Omega^2$	-	- /	61	132	ns	
t <sub>f</sub>	Turn-Off	Fall Time		(Note 4)			2.6	15	ns	
Drain-Sou	rce Diod	e Characteristics								
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current				-	-	17	Α		
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diod		Diode Forwa			-	-	42	Α	
V <sub>SD</sub>	Drain to	rain to Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_{SD} = 17 \text{ A}$				-	-	1.2	V	
t <sub>rr</sub>	Reverse	Recovery Time	V <sub>GS</sub> =	$V_{GS} = 0 V, I_{SD} = 17 A,$ $dI_F/dt = 100 A/\mu s$		-	511	-	ns	
Q <sub>rr</sub>	Reverse	Recovery Charge	dl <sub>F</sub> /dt			-	12	-	μC	
lotes:										
		imited by maximum junction tempe	rature.							
. I <sub>AS</sub> = 3.4 A, R <sub>G</sub> =										
		$_{DD} \le BV_{DSS}$ , starting $T_J = 25^{\circ}C$ erating temperature typical character	eristic.							

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1.4

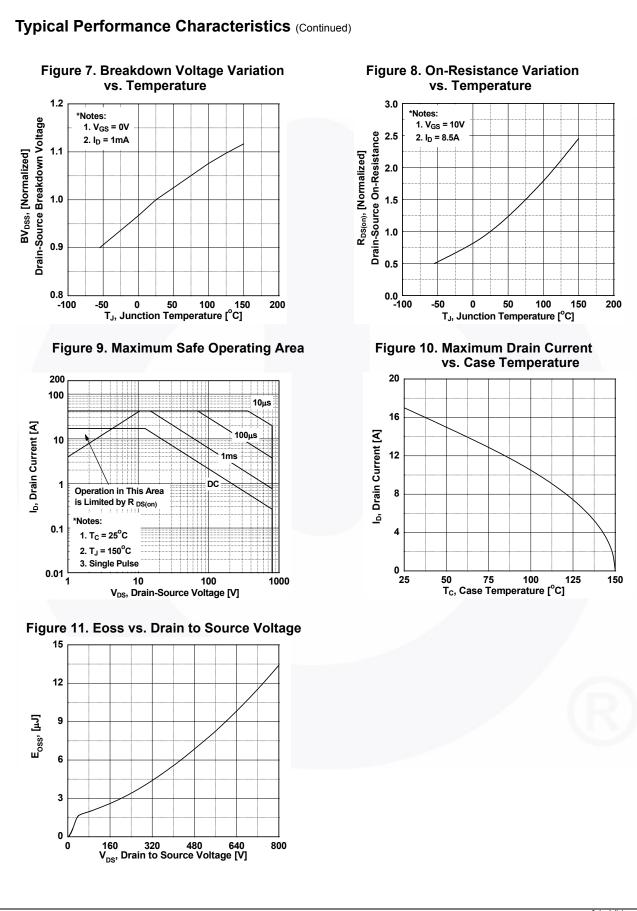


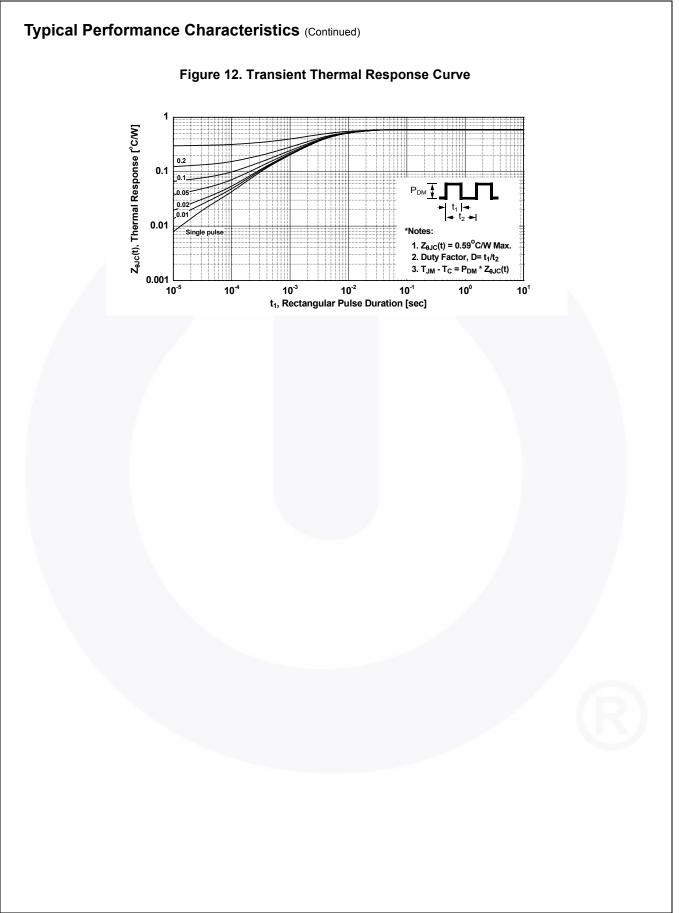
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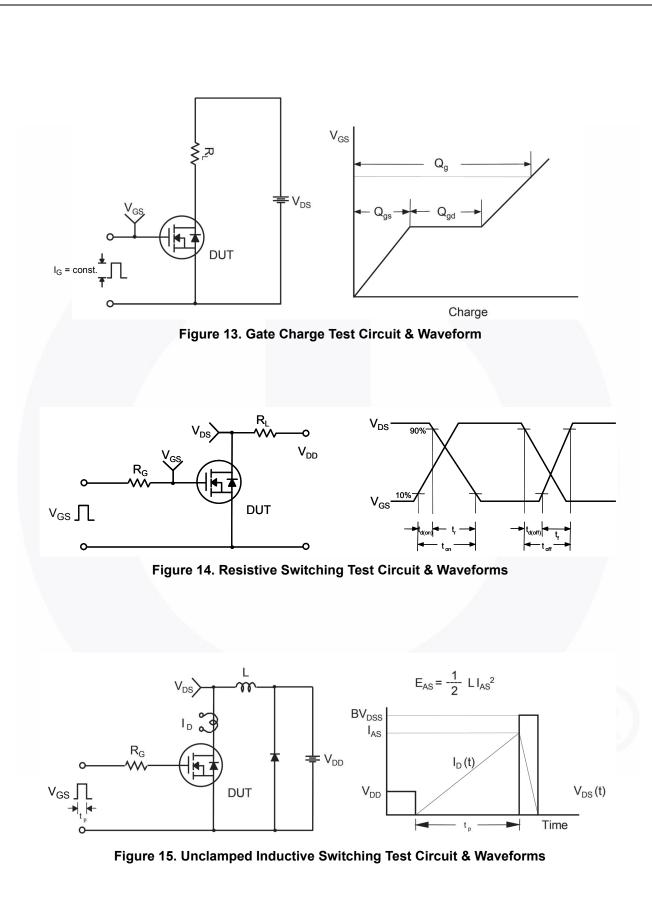
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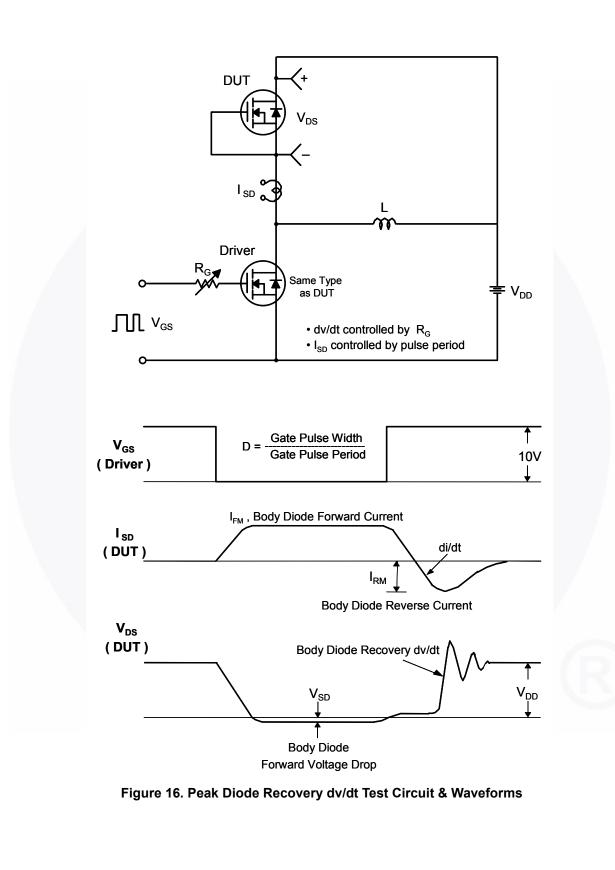


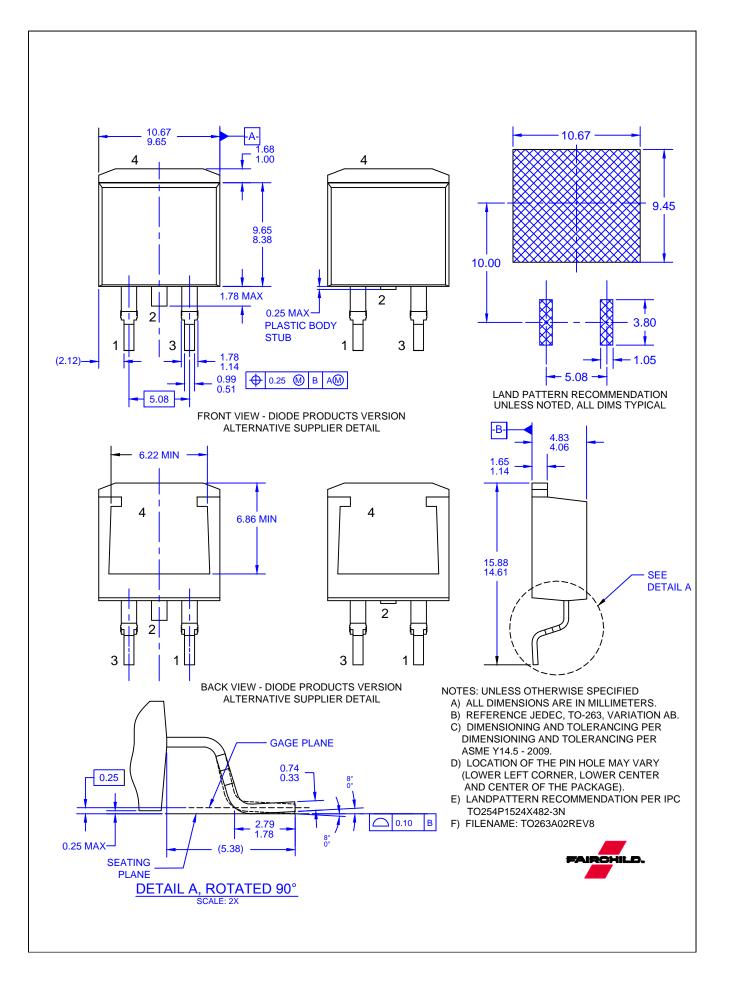






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